SNOS552D - MAY 1998 - REVISED APRIL 2013

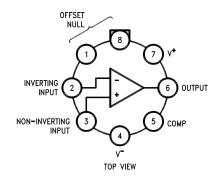
## **LM725 Operational Amplifier**

Check for Samples: LM725

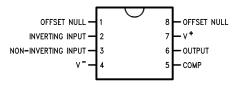
### **FEATURES**

- High Open Loop Gain: 3,000,000
- Low Input Voltage Drift 0.6 μV/°C
- High Common Mode Rejection 120 dB
- Low Input Noise Current 0.15 pA/√Hz
- Low Input Offset Current 2 nA
- High Input Voltage Range ±14V
- Wide Power Supply Range ±3V to ±22V
- Offset Null Capability
- Output Short Circuit Protection

### **CONNECTION DIAGRAM**



Metal Can Package



**Dual-In-Line Package** 

### DESCRIPTION

The LM725/LM725A/LM725C are operational amplifiers featuring superior performance in applications where low noise, low drift, and accurate closed-loop gain are required. With high common mode rejection and offset null capability, it is especially suited for low level instrumentation applications over a wide supply voltage range.

The LM725A has tightened electrical performance with higher input accuracy and like the LM725, is guaranteed over a -55°C to +125°C temperature range. The LM725C has slightly relaxed specifications and has its performance guaranteed over a 0°C to 70°C temperature range.

#### TYPICAL APPLICATIONS

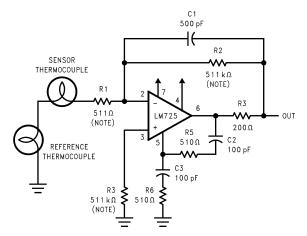


Figure 1. Thermocouple Amplifier

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Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SNOS552D-MAY 1998-REVISED APRIL 2013

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### **ABSOLUTE MAXIMUM RATINGS (1)**

If Military/Aerospace specified devices are required, contact the Texas Instruments Semiconductor Sales Office/ Distributors for availability and specifications. (2)

±22V
500 mW
±5V
±22V
−65°C to +150°C
260°C
150°C
−55°C to +125°C
−55°C to +125°C
0°C to +70°C

<sup>(1) &</sup>quot;Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but **do not** guarantee specific performance limits.

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<sup>(2)</sup> For Military electrical specifications RETS725AX are available for LM725AH and RETS725X are available for LM725H.

<sup>(3)</sup> Derate at 150°C/W for operation at ambient temperatures above 75°C.

<sup>(4)</sup> For supply voltages less than ±22V, the absolute maximum input voltage is equal to the supply voltage.

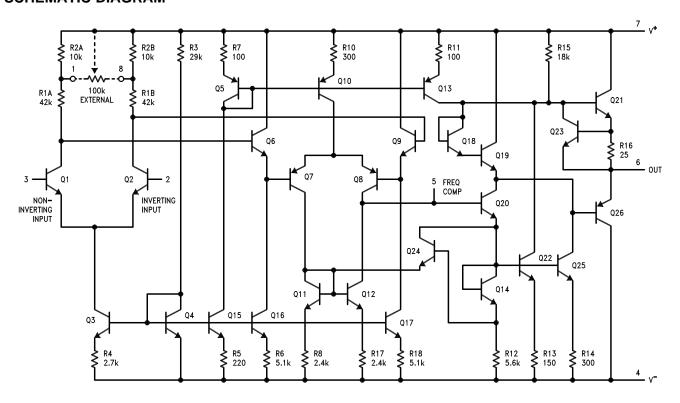
### **ELECTRICAL CHARACTERISTICS (1)**

		LM725A				LM725			LM725C		
Parameter	Conditions	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
Input Offset Voltage (Without External Trim)	$T_A = 25^{\circ}C$ , $R_S \le 10 \text{ k}\Omega$			0.5		0.5	1.0		0.5	2.5	mV
Input Offset Current	T <sub>A</sub> = 25°C		2.0	5.0		2.0	20		2.0	35	nA
nput Bias Current	T <sub>A</sub> = 25°C		42	80		42	100		42	125	nA
nput Noise Voltage	T <sub>A</sub> = 25°C										
	$f_o = 10 \text{ Hz}$		15			15			15		nV/√Hz
	f <sub>o</sub> = 100 Hz		9.0			9.0			9.0		nV/√Hz
	f <sub>o</sub> = 1 kHz		8.0			8.0			8.0		nV/√Hz
Input Noise Current	$T_A = 25^{\circ}C$										
	$f_o = 10 \text{ Hz}$		1.0			1.0			1.0		pA/√Hz
	f <sub>o</sub> = 100 Hz		0.3			0.3			0.3		pA/√ <del>Hz</del>
	$f_o = 1 \text{ kHz}$		0.15			0.15			0.15		pA/√ <del>Hz</del>
Input Resistance	T <sub>A</sub> = 25°C		1.5			1.5			1.5		ΜΩ
Input Voltage Range	T <sub>A</sub> = 25°C	±13.5	±14		±13.5	±14		±13.5	±14		V
Large Signal Voltage Gain	$T_A = 25^{\circ}C,$ $R_L \ge 2 \text{ k}\Omega,$ $V_{OUT} = \pm 10\text{V}$	1000	3000		1000	3000		250	3000		V/mV
Common-Mode Rejection Ratio	$T_A = 25^{\circ}C$ , $R_S \le 10 \text{ k}\Omega$	120			110	120		94	120		dB
Power Supply Rejection Ratio	$T_A = 25^{\circ}C$ , $R_S \le 10 \text{ k}\Omega$		2.0	5.0		2.0	10		2.0	35	μV/V
Output Voltage Swing	$T_A = 25$ °C,										
	$R_L \ge 10 \text{ k}\Omega$	±12.5	±13.5		±12	±13.5		±12	±13.5		V
	$R_L \ge 2 k\Omega$	±12.0	±13.5		±10	±13.5		±10	±13.5		V
Power Consumption	T <sub>A</sub> = 25°C		80	105		80	105		80	150	mW
Input Offset Voltage (Without External Trim)	R <sub>S</sub> ≤ 10 kΩ			0.7			1.5			3.5	mV
Average Input Offset Voltage Drift (Without External Trim)	$R_S = 50\Omega$			2.0		2.0	5.0		2.0		μV/°C
Average Input Offset Voltage Drift (With External Trim)	$R_S = 50\Omega$		0.6	1.0		0.6			0.6		μV/°C
Input Offset Current	$T_A = T_{MAX}$		1.2	4.0		1.2	20		1.2	35	nA
	$T_A = T_{MIN}$		7.5	18.0		7.5	40		4.0	50	nA
Average Input Offset Current Drift			35	90		35	150		10		pA/°C
Input Bias Current	$T_A = T_{MAX}$		20	70		20	100			125	nA
	$T_A = T_{MIN}$		80	180		80	200			250	nA
Large Signal Voltage	R <sub>L</sub> ≥ 2 kΩ										
Gain	$T_A = T_{MAX}$	1,000,000			1,000,000			125,000			V/V
	$R_L \ge 2 k\Omega$										
	$T_A = T_{MIN}$	500,000			250,000			125,000			V/V
Common-Mode Rejection Ratio	R <sub>S</sub> ≤ 10 kΩ	110			100				115		dB
Power Supply Rejection Ratio	R <sub>S</sub> ≤ 10 kΩ			8.0			20		20		μV/V
Output Voltage Swing	$R_L \ge 2 k\Omega$	±12		1	±10			±10			V

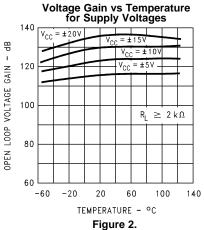
<sup>(1)</sup> These specifications apply for  $V_S = \pm 15V$  unless otherwise specified.



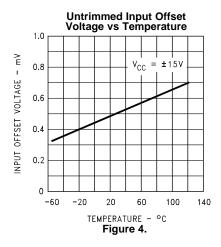
### **SCHEMATIC DIAGRAM**

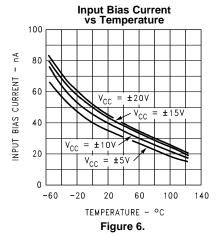


#### TYPICAL PERFORMANCE CHARACTERISTICS

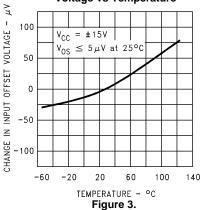




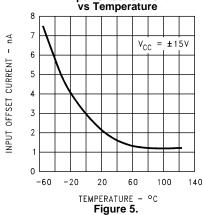




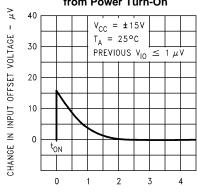
# Change in Trimmed Input Offset Voltage vs Temperature



**Input Offset Current** 



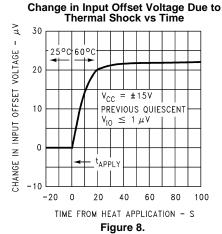
# Stabilization Time of Input Offset Voltage from Power Turn-On



TIME FROM POWER APPLICATION - MIN Figure 7.



### TYPICAL PERFORMANCE CHARACTERISTICS (continued)



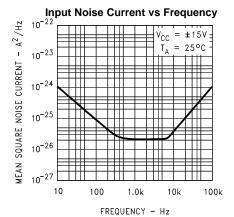
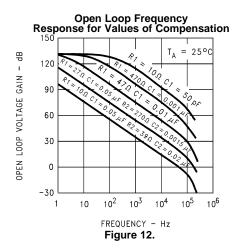
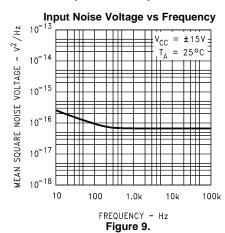
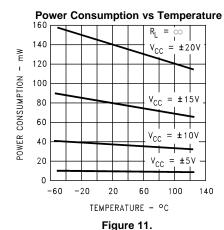


Figure 10.







### **Values for Suggested Compensation Networks**

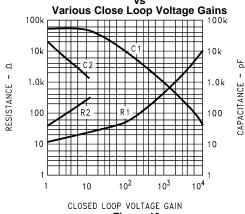
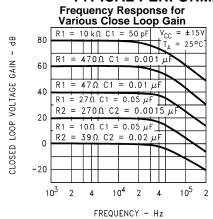


Figure 13.

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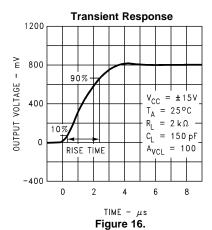
### TYPICAL PERFORMANCE CHARACTERISTICS (continued)



- (1) Performance is shown using recommended compensation networks.
- (1) Performance is shown using recommended compensation networks.

Figure 15.

Figure 14.



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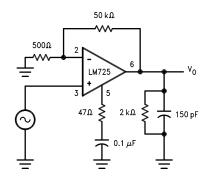


Figure 17. Transient Response Test Circuit

### **AUXILIARY CIRCUITS**

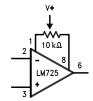


Figure 18. Voltage Offset Null Circuit

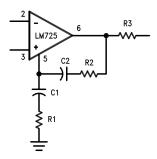


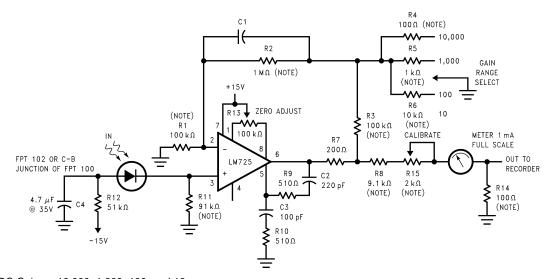
Figure 19. Frequency Compensation Circuit

**Table 1. Compensation Component Values** 

A <sub>V</sub>	R <sub>1</sub> (Ω)	C <sub>1</sub> (μF)	R <sub>2</sub> (Ω)	C <sub>2</sub> (μF)
10,000	10k	50 pF		
1,000	470	0.001		
100	47	0.01		
10	27	0.05	270	0.0015
1	10	0.05	39	0.02

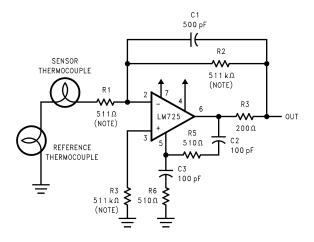
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### TYPICAL APPLICATIONS



DC Gains = 10,000; 1,000; 100; and 10 Bandwidth = Determined by value of C1

Figure 20. Photodiode Amplifier



```
\begin{split} \frac{R2}{R5} &= \frac{R6}{R7} \text{ for best CMR} \\ R1 &= R4 \\ R2 &= R5 \\ Gain &= \frac{R6}{R2} + \left(\frac{2R1}{R3}\right) \\ DC \ Gain &= 1000 \\ Bandwidth &= DC \ to 540 \ Hz \\ Equivalent Input Noise &= 0.24 \ \mu\text{V}_{rms} \end{split}
```

Indicates  $\pm 1\%$  metal film resistors recommended for temperature stability.

Figure 21. Thermocouple Amplifier



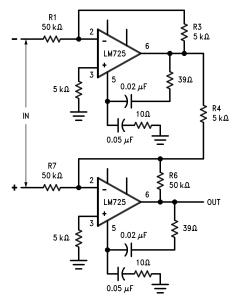
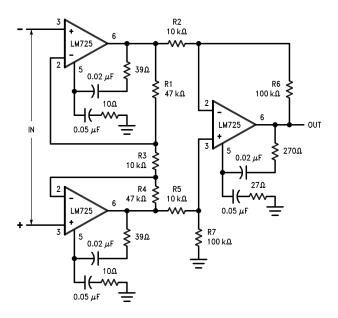


Figure 22. ±100V Common Mode Range Differential Amplifier



```
\frac{R1}{R6} = \frac{R3}{R4} \text{ for best CMRR}
R3 = R4
R1 = R6 = 10 R3
Gain = \frac{R6}{R7}
```

Figure 23. Instrumentation Amplifier with High Common Mode Rejection

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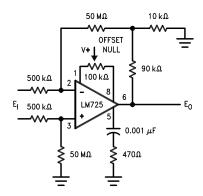


Figure 24. Precision Amplifier  $A_{VCL} = 1000$ 

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### **REVISION HISTORY**

Changes from Revision C (April 2013) to Revision D					
•	Changed layout of National Data Sheet to TI format		11		

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